

LCD Controllers



An LCD controller is an LSI that performs control for displaying data such as text or graphics processed by a CPU on an LCD panel. The data processed by the CPU is stored in VRAM (Video RAM, normally composed of SRAM or DRAM). The LCD controller reads this stored display data from VRAM and transmits them to the LCD driver, and then they are displayed on the LCD panel (see Figure 1).

The LCD controller is an important device for LCD displays. Our Semiconductor Operations Division, thinking of "displays" as one business concept itself, is focusing efforts on it as a key device.

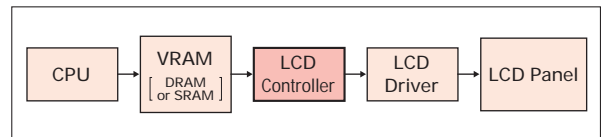


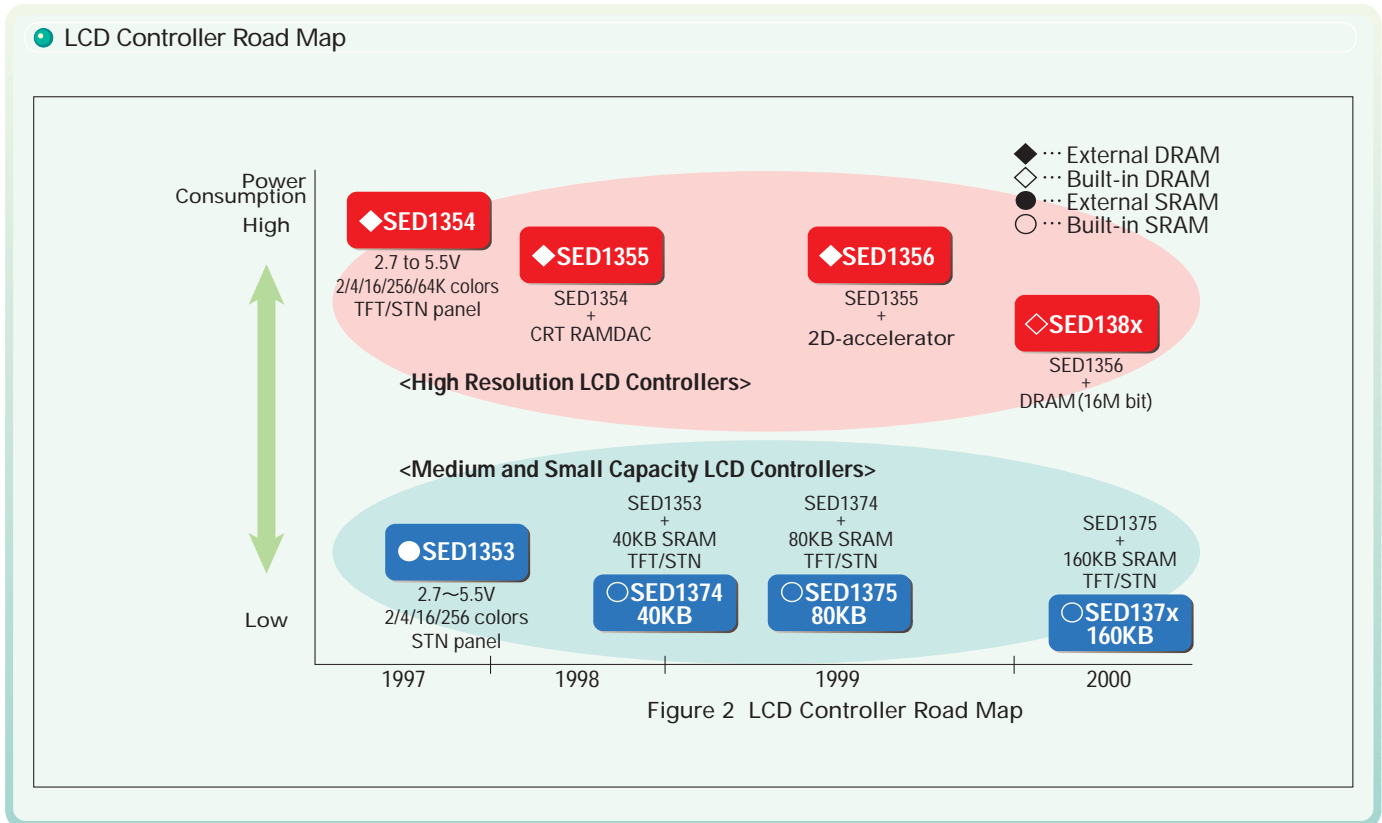
Figure 1 Flow of Display Data for LCD Display

Our LCD controllers use our own original architecture, with a product line including products for medium and small capacity LCD panels and for high resolution as shown in the road map (see Figure 2). VRAM for medium and small capacity LCD controller supports SRAM to reduce power consumption, and that for high resolution LCD controller supports DRAM to match CPU memory. With the high resolution products, it is possible to display not only on LCDs but also CRTs.

Medium and Small Capacity LCD Controllers

Medium and small capacity LCD controllers are widely used for LCDs in FA equipment and OA equipment. This series has built-in VRAM (SRAM) that stores display data, and has achieved reductions in power consumption and mounting area. The already released SED1374 has a 40KB SRAM, and the SED1375 released in June has an 80KB SRAM built-in. With the next LCD controller, we plan to incorporate a 160KB SRAM.

With built-in SRAM, compared to the current SED1353 with externally mounted SRAM, the power consumption is halved. This means that applications from FA equipment and OA equipment to palm top PCs as well as compact portable equipment such as the next generation cellular phones that have larger capacity display data are covered.



High Resolution LCD Controllers

The SED1354 is an LCD controller that targets Windows CE applications. It received approval from Microsoft Corp. to be the standard LCD controller for Windows CE 2.0, and it is recommended as an external LCD controller by various RISC manufacturers that support Windows CE.

We are moving forward with expansion of functions using SED1354 as a base (see Figure 3). The SED1355 that can also display simultaneously on a CRT and supports a Hardware rotate by 90° has already been released. In September we plan to release the SED1356 that has an additional built-in 2D-accelerator, a 90°, 180° and 270° Hardware rotate function and is capable to generate a TV output signal (PAL, NTSC). The SED1386 is also the first Graphic Controller which is able to handle two different images on the outputs (Ghost Mode). Also in the future, we will develop the SED138x with built-in VRAM (SDRAM) to reduce consumption power even further and to be independent from the memory market.

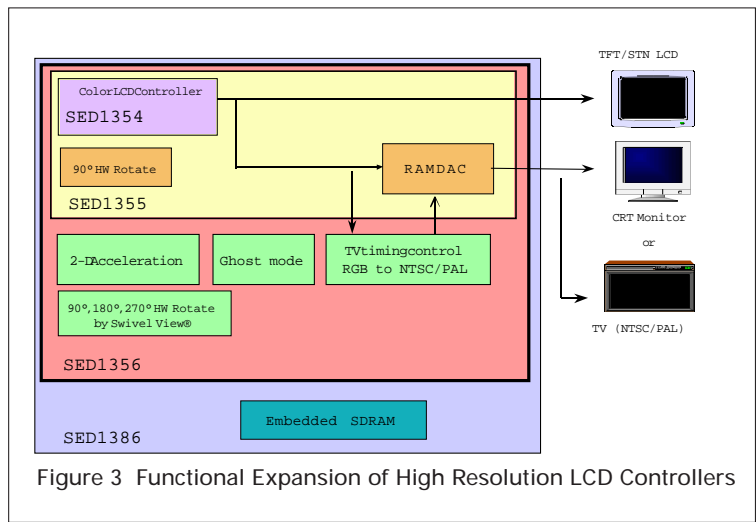


Figure 3 Functional Expansion of High Resolution LCD Controllers

High Integration Low Power Standard Cell



Along with higher level functions and higher performance levels of electronic equipment, there has been increased demand for high integration and lower power consumption for ASIC. To meet these demands, we have released the SCB50000 Series of 0.35 μm process standard cells (cell based ICs). Therefore we have three ways of gate arrays, embedded arrays, and standard cells to handle a wide variety of your needs.

The SCB50000 Series

Standard cells have the most of flexibility by customizing the overall process. Utilizing this, we optimize gate size for all logic cells used within an LSI. As result of it, compared to gate arrays of the same process, approximately 40% of the chip area and approximately 30% of the power consumption are realized.

Series Name	Internal Gate Power Consumption(μW) *1	Chip Area Ratio (%)
SLA50000H Series (gate arrays)	0.765	100
SSL50000 Series (embedded arrays)	0.451	73
SCB50000 Series	0.222	40

*1: Power consumption when operating the basic circuit (FF) at 3.3 V, 1 MHz

List of Functional Cells for SCB50000

The following functional cells are available for SCB50000 (also used for SSL50000) to shorten customer development time.

CPU	E0C33*2, ARM7TDMI
Interface	LVDS*, USB*, IrDA, PCMCIA
Memory	RAM (1MB Max.), ROM (2MB Max.), Flash (4MB Max.)
Peripheral	DMAC, RTC, USART, PIT, PPI, PIC, UART
LCD Controller	SED1352, SED1354*
Multiplier	4 x 4 bit through 32 x 32 bit
Analog	A/D converter, D/A converter, PLL

* : Under development *2: Seiko Epson original CPU

Applications

- Portable equipment requiring super low power consumption (Data banks, cellular phones, digital still cameras, etc.)

Windows® CE development kit for CARD-PC



Windows® CE development kit for CARD-PC is the ideal and easy software development kit for quick and cost saving development of Windows® CE system. Windows® CE development kit for CARD-PC includes device drivers for CARD-PC, Platform builder and EPSON original utilities which makes easy for OEMs to build up and optimize Windows® CE for their own system. It enables OEMs to develop and optimize the Windows® CE system without knowledge of Windows® CE expertise.

Windows® CE development kit is available in two versions. One is for CARD-586 which is EASI compatible card. OEMs can easily introduce Windows® CE system into existing CARD-586 system. Also OEMs can make use of many tools and peripherals for x86 architecture system. Another one is for CARD-E09 (SH-CARD). CARD-E09 is suitable for low-power/low cost Windows® CE based embedded system.

● Contents of Windows® CE Development Kit

- Development kit CD
 - Device drivers for CARD-PC
 - Platform builder 2.11
 - Debugging tool
 - Utility software
 - Licences: The Development Kit doesn't include any license, prototype licences up to 10 pcs can be obtained for development. For Massproduction the Minimum order Quantity is 1000 licenses/project!
- LOADER, OAL service code, dedicated BIOS (CARD-586)
Video, PCMCIA, LAN, HDD, Serial, Parallel, etc.
Development tool from Microsoft®
PPSH cable, Serial cable (SH-CARD), Debugging tool
Software to build the Windows® CE for the target system

● EPSON Original Functions in Development Kit

- Adaptations for LCDs (TFT, STN)
 - Data store when the power is off
 - LOGO display function
 - Monitoring function in boot up
 - Multiple boot function
- Changing LCDs and resolutions are done without Rebuild WCE
RAM contents can be saved to a storage device when power is off
Your company LOGO is displayed when Windows® CE is boot up

Model No: ● DIO51L3 is the Development Kit applicable to Card-586
● SCE88J4X01 is applicable for CARD-E09A (SH-CARD)



Microcontroller



● EOC63 Family:

The high performance 4 bit EOC63 family, upper version of the proven EOC62 core, is dedicated to offer a cheap 4 bit solution regarding 8 bit application. An unique ROM structure by 13bit and a wide range of technical features underline the high performance description. Flexible instruction code, short cycle operation speed and wide ROM access range, based on EPSON's low power consumption technology are only some highlights of this EOC63 family. To satisfy the most telecommunication requirements, EPSON offers a complete solution with the EOC63500 Series including DTMF/DP modulator and FSK indicator.

Model	Power Voltage (V)	SupplyCurrent			Clock frequency (Hz)	Memory(bit)		I/Port(bit)			Interrups		LCDDrivers		Features	Package	
		Operating	Halt	Sleep		ROM (code)	RAM	I	O	I/O	Ext.	Int.	Com.	Seg.			
E0C63A08	0.9to3.6	10µA	1.5µA		32.768K		2,048x4			20	20		6	8,16,17	72	GateArray Melody IC	208QFP Die
E0C63B08		300µA	1.2µA		32.768K	1M	8,192x13					2	5	2,3,4	32	GateArray	100QFP Die
E0C63B07		5.3µA	1.2µA		400K		1,024x4			8	12		6		60	GateArray/MelodyIC Dot-Matrix	160QFP Die
E0C63557	2.2to5.5	3.5µA	1.2µA		32.768												
E0C63558		85µA	1.5µA		32.768K	3.58M	8,192x13	5,120x4	8	12	16	2	4	8,16,17	40	DTMF/DT	128QFP Die
E0C63559		10µA	1.5µA		32.768K	3.58M	8,192x13	5,120x4	8	12	16	2	4	8,16,17	40	DTMF/DT, FSK	128QFP Die
E0C63404	1.8to6.4	10µA	0.8µA		32.768K	1M	4,096x13	2,688x4	8	12	12	2					
E0C63454		270µA			32.768K	1M	4,096x13	1,024x4	4	4	8	1		8,16,17	40	MultipleTimers 2,048x4 Data ROM SoundGenerator SerialInterface	128QFP Die
E0C63455		10µA			32.768K	4M	4,096x13	1,024x4					4	8			
E0C63456		1mA	1µA		32.768K	4M	8,129x13	5,120x4			12			8,16,17	60	Dot-Matrix	144QFP Die
E0C63457		4µA			32.768K	4M	16,384x13	1,792x4	8				2				
E0C63466		10µA			32.768K	4M					12						
E0C63358	0.9to3.6	6µA	2µA		32.768K	4.5M	8,192x13	512x4	9	12	20	2			32	A/DConverter LCDDriver	64QFP Die
E0C63256	2.7to5.5	900µA	740µA		2M	6,144x13	256x4	4	4	8	1	4	2,3,4	20	A/DConverter Sleep Mode		
E0C63158	0.9to3.6	1.2mA	620µA		4.194M											A/DConverter SVD	

● EOC88 Family:

Built around the EOC88000, EPSON's powerful 8 bit core CPU, the EOC88 family line up integrates a wide choice of ROM and RAM sizes, LCD Controllers and drivers, touch panel controller, serial ports and other high performance peripheral circuits into a single chip design. With operation voltages down to 1.8V and clock speed up to 10 MHz, these microcontrollers feature the same ultra low power consumption as normally seen in 4bit MCU's only.

Model	Power Voltage (V)	SupplyCurrent			Clock frequency (Hz)	Memory		I/Port(bit)			Interrups		LCDDrivers		Features	Package						
		Operating	Halt	Sleep		ROM	RAM	I	O	I/O	Ext.	Int.	COM x SEG									
E0C88104	1.8to5.5	14µA	2µA	0.3µA	32.768K	4KB	256B	10	9	8	2	4		MultipleI/O Analog Comparator Sound Generator SerialInterface	80QFP/100QFP Die							
E0C88112		2mA	2µA	0.3µA	32.768K	12KB																
E0C88308 ¹	1.8to5.5	14µA	2µA	0.3µA	32.768K	8KB	256B	9	5	8	2	4	8/16x57; 32x41	Dot-Matrix/CD-Driver SerialInterface LCD-VoltageBooster High Speed (8.2MHz) High Speed Operation Analog Comparator Sound Generator DisplayMemory	160QFP Die							
E0C88316 ¹		2mA	2µA	0.3µA	32.768K	16KB										2KB	10	9	8	2	4	8/16x67; 32x51
E0C88317 ¹		14µA	1µA	0.2µA	32.768K	16KB																
E0C88348 ¹		2mA	2µA	0.3µA	32.768K	48KB										2KB	10	9	8	2	4	8/16x67; 32x51
E0C88365	2.2to5.5	14µA	2µA	0.3µA	32.768K	64KB	3KB	10	17	8	2	4	18x80	Analog Comparator Sound Generator	Die							
E0C88832 ²	1.8to5.5	10µA	2µA	0.3µA	32.768K	32KB	1.5KB	9	5	8	2	4	8/16x57; 32x41	High Speed (8.2M) no access to ext. memory Sound Generator DisplayMemory	128QFP Die							
E0C88862 ²		1.3mA	2µA	0.3µA	32.768K	60KB										2KB	10	9	8	2	4	8/16x67; 32x51
E0C88F360 ³	1.8to5.5	18µA	3µA	TBD	32.768K	32KB	2KB	10	9	8	2	5	8/16/32x51	FlashROM, A/DConverter Soundgenerator High Speed Operation	176QFP Die							
E0C88408	1.8to5.5	15µA	3µA	0.6µA	32.768K	8KB	3.75KB	12	3	26	2	4	LCDController	Sound Generator Build in VRAM	100QFP Die							
E0C88409		2mA	3µA	0.6µA	32.768K	4.2M										A/D-,D/AConverter Touch-PanelController						

¹MTP-Tool available (nomassproduction)

²Released soon

³MTP-Tool released soon (nomassproduction)



New package standard for oscillator

In its long tradition of creating standards in designing smaller and smaller crystal oscillators, EPSON has set yet another milestone: The CE type package.

Smaller than any other oscillator in the market, the new SG-8002CE is the first to feature this ultra-miniature package. With a surface area of 2.5 x 3.2 mm², the oscillator is only 1mm in height, making it suitable in environments, where low profile is vital. The one time programmable SG-8002CE is one time frequency programmable and available from 1MHz to 135MHz in three different combinations of stability and operating temperature range.

Like the other oscillators in the SG-8002 series, the SG-8002CE applies an internal PLL frequency generation circuit and combines extremely low delivery times with versatility and reasonable prices.

Specifications

Frequencies	1MHz to 135 MHz
Operating voltage	5V or 3.3V
Output Waveforms	TTL, HCMOS or 3.3V CMOS
Stabilities	+/- 50ppm (-20° to 70°) +/- 100ppm (-20° to 70°) +/- 100ppm (-40° to 85°)
Aging	+/-5ppm/ 1 st year
Options	Output enable or standby option
Package Size	3,2 x 2,5 x 1,0 mm

Check our website for datasheets and the other members of this industry standard oscillator family.

Ultra Compact SMD Package for Crystal Unit

The MC-146 is a compact SMD crystal unit developed for portable equipment for which smaller size is in great demand. Using a newly developed package for high density mounting, parts occupation area (including land pattern) is the smallest level in the industry, and the thickness is 0.1 mm thinner than our previous model.

Features

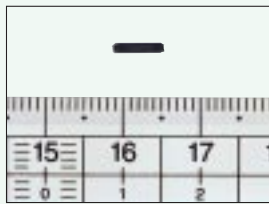
- Compact SMD plastic mold package
- The smallest level part occupation area in the industry
- High reliability cylinder type crystal unit built-in

Specifications

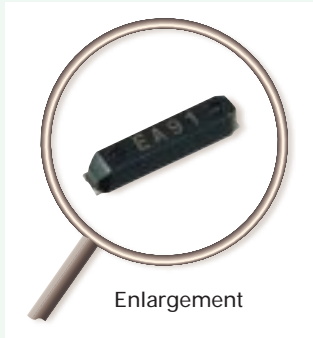
Frequencies	32.768k, 75k, 76.8k Hz
Operating temperature	-40 to + 85°C
Serial resistance	65kΩ (Max. at 32.768kHz crystal)
Frequency tolerance	± 20, ± 50 ppm
Load capacity	7.0 pF
External dimensions	6.9 x 1.4 x 1.3 mm

Applications

- Compact portable equipment such as cellular phones



Full size



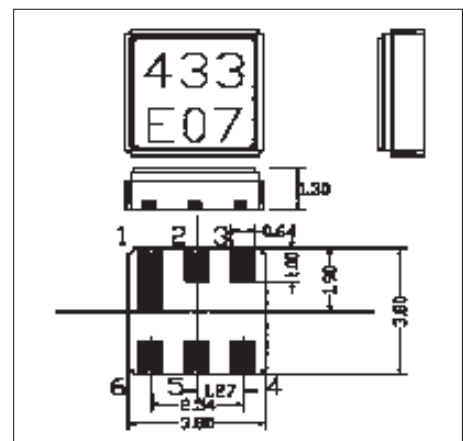
Enlargement

A new miniature SAW resonator for keyless entry applications

EPSON's new ultraminiature SAW resonator FS-335 is yet another step in EPSON's aggressive strategy to develop smaller and more versatile frequency control products. With its extremely small package of 3.8 x 3.8 x 1.3 mm³ and its full automotive operating temperature range, it is ideal for handheld applications like keyless entry systems and similar remote controls. The available frequencies range from 300MHz to 900MHz, covering the frequencies most commonly used in such applications. The components will be available in August in sample quantities and by the end of this year for mass production.

Specifications

Frequencies	300MHz to 900MHz
Stabilities	+/-50ppm to +/-100ppm
Operating temperature	-40°C to +85°C



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